

# GP2L22

## Subminiature, High Sensitivity Photointerrupter

### ■ Features

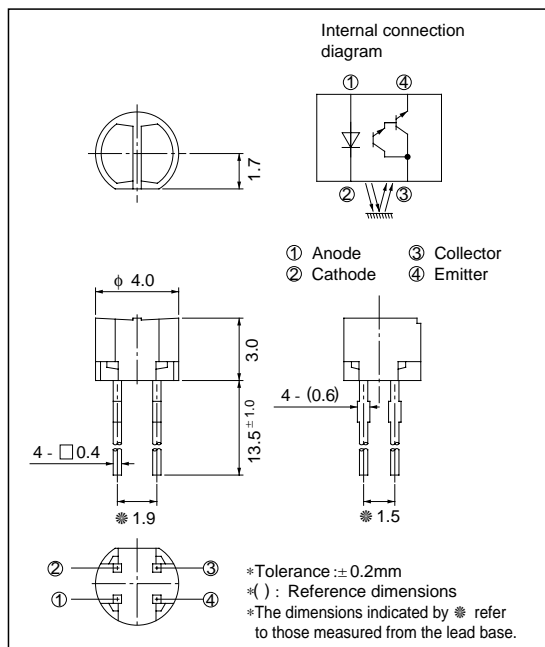
1.  $\phi$  4mm compact resin mold type
2. High sensitivity ( $I_C$ : MIN. 0.5mA at  $I_F = 4\text{mA}$ )
3. Optimum detection distance: 0.6mm
4. Visible light cut-off type

### ■ Applications

1. Audio equipment, VCRs

### ■ Outline Dimensions

(Unit : mm)

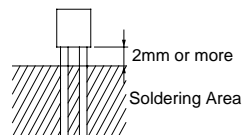


### ■ Absolute Maximum Ratings

( $T_a = 25^\circ\text{C}$ )

Parameter		Symbol	Rating	Unit
Input	Forward current	$I_F$	50	mA
	Reverse voltage	$V_R$	6	V
	Power dissipation	$P$	75	mW
Output	Collector-emitter voltage	$V_{CEO}$	35	V
	Emitter-collector voltage	$V_{ECO}$	6	V
	Collector current	$I_C$	50	mA
	Collector power dissipation	$P_C$	75	mW
Total power dissipation		$P_{tot}$	100	mW
Operating temperature		$T_{opr}$	- 25 to + 85	$^\circ\text{C}$
Storage temperature		$T_{sg}$	- 40 to + 100	$^\circ\text{C}$
*1 Soldering temperature		$T_{sol}$	260	$^\circ\text{C}$

\*1 For 3 seconds by manual soldering



■ Electro-optical Characteristics

(Ta = 25°C)

Parameter			Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input	Forward voltage		V <sub>F</sub>	I <sub>F</sub> = 20mA	-	1.2	1.4	V
	Reverse current		I <sub>R</sub>	V <sub>R</sub> = 6V	-	-	10	μ A
Output	Collector dark current		I <sub>CEO</sub>	V <sub>CE</sub> = 10V	-	-	10 <sup>-6</sup>	A
Transfer charac- teristics	*2Collector current		I <sub>C</sub>	V <sub>CE</sub> = 5V, I <sub>F</sub> = 4mA	0.5	-	15	mA
	Response time	Rise time	t <sub>r</sub>	V <sub>CE</sub> = 2V, I <sub>C</sub> = 10mA	-	80	400	μ s
		Fall time	t <sub>f</sub>	R <sub>L</sub> = 100 Ω , d = 1mm	-	70	400	μ s
	*3Leak current		I <sub>LEAK</sub>	V <sub>CE</sub> = 5V, I <sub>F</sub> = 4mA	-	-	5	μ A

\*2 The condition and arrangement of the reflective object are shown in the right drawing.

\*3 Without reflective object

The ranking of collector current shall be classified into the following 5 ranks.

Rank	$I_C$ (mA)
A	4.0 to 15.0
B	1.45 to 5.4
A or B	1.45 to 15.0
B or C	0.5 to 5.4
A, B or C	0.5 to 15.0

Test Condition and Arrangement for Collector Current

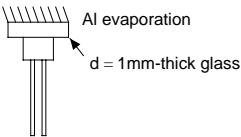


Fig. 1 Forward Current vs. Ambient Temperature

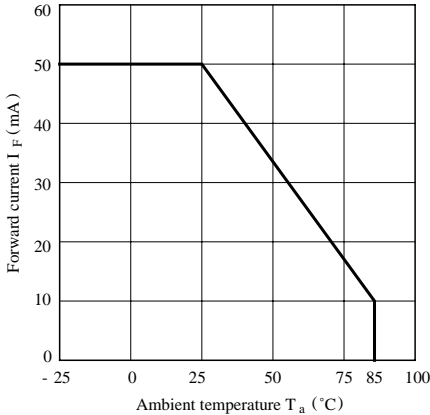


Fig. 2 Power Dissipation vs. Ambient Temperature

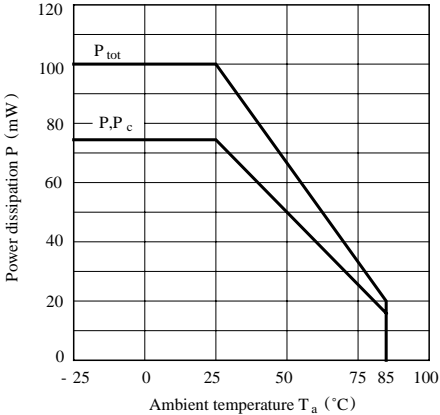


Fig. 3 Forward Current vs. Forward Voltage

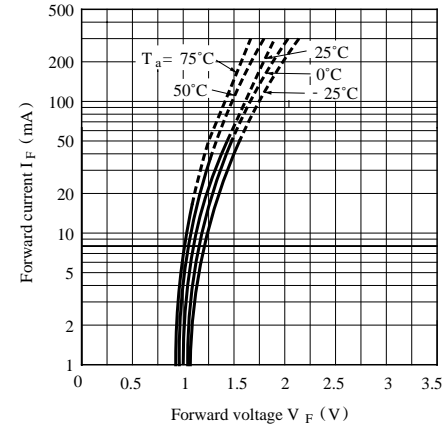


Fig. 4 Collector Current vs. Forward Current

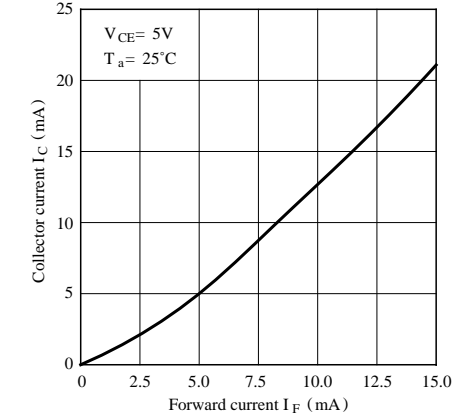


Fig. 5 Collector Current vs. Collector-emitter Voltage

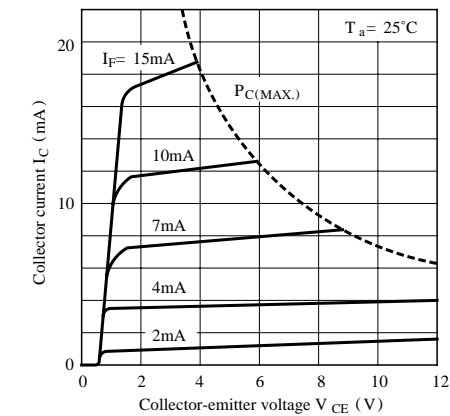


Fig. 6 Collector Current vs. Ambient Temperature

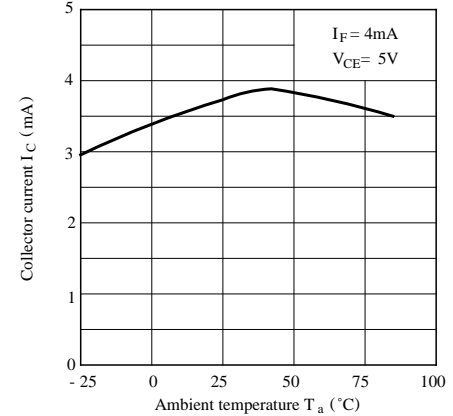


Fig. 7 Collector Dark Current vs. Ambient Temperature

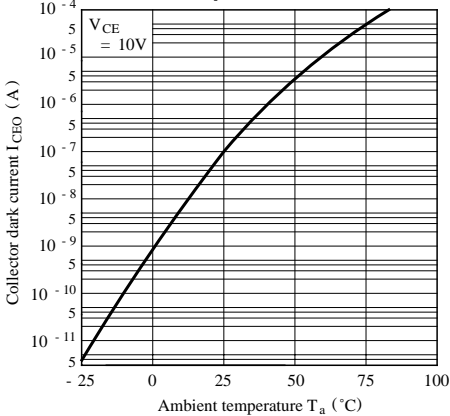
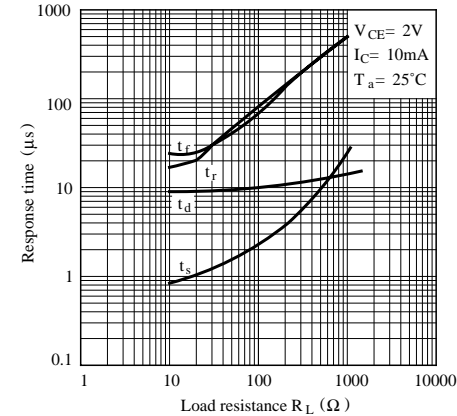
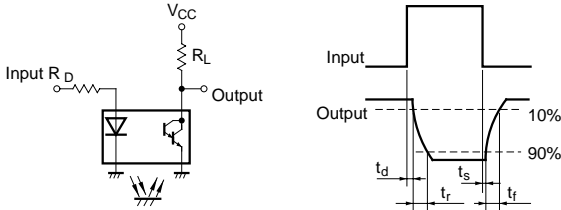


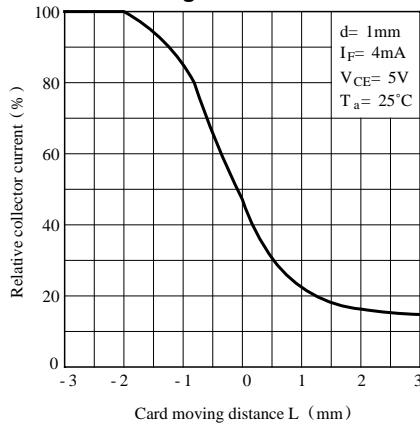
Fig. 8 Response Time vs. Load Resistance



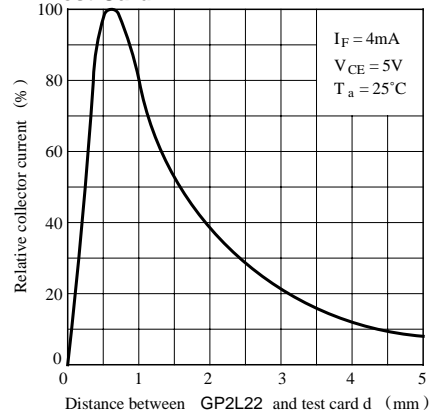
### Test Circuit for Response time



**Fig.10 Relative Collector Current vs. Card Moving Distance**



**Fig.9 Relative Collector Current vs. Distance between Sensor and Test Card**



### Test Condition for Distance & Detecting Position Characteristics

Correspond to Fig.9

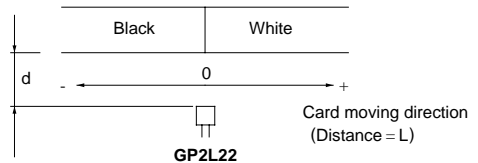
SHARP OMS TEST CARD  
(White)



GP2L22

Correspond to Fig.10

SHARP OMS TEST CARD



### ■ Precautions for Use

- (1) Perform soldering manually.
- (2) Please refrain from soldering under preheating and refrain from soldering by reflow.
- (3) As for other general cautions, refer to the chapter "Precautions for Use".

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    - Test and measurement equipment
    - Industrial control
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